

Photocentric's HighTemp DL400 is the first Photocentric high temperature resistant resin possessing superior properties of both strength and stiffness. It can handle impact, compression, fatigue, high temperatures and moisture without bending or deforming, able to print with an impressive layer thickness of 350µm.

Optimised for:	Hot fluid and gas manifolds	Moulds and inserts
	 Heat resistant housings and fixtures 	 Outdoor applications

Unique features:



Temperature resistant (HDT 230 °C)



Excellent long-lasting performance under heat and stress



Print at 350 µm layer thickness







Dry and smooth surface finish and ability to print fine details



HighTemp DL400 Properties

Tensile Properties		
Tensile Modulus *	4000 MPa	ASTM D638
Ultimate Tensile Strength *	80 MPa	ASTM D638
Elongation at break *	4%	ASTM D638
Flexural Properties		
Flexural Modulus *	3300 MPa	ASTM D790
Flexural Strength *	109 MPa	ASTM D790
Impact Properties		
Impact Strength Notched Izod *	15.6 J/m	ASTM D256
Impact Strength Notched Izod *	3.1 kJ/m2	ISO 180
General Properties		
Hardness *	95 Shore D	ASTM D2240
Heat Deflection Temperature *	230 °C	ASTM D648 (0.455 MPa)
Water Absorption (Short Term)	0.35%	ASTM D570
Viscosity	650 cPs	At 25°C Brookfield spindle 3
Density	1.10 g/cm3	
Storage	10 <t>50°C</t>	
Biocompatibility		
Cytotoxicity*	Passed	ISO 10993-5

^{*}Mechanical properties stated based on fully cured material.



We are constantly reviewing and improving our range of high-performance materials. For the very latest information, please visit the Photocentric website



Pre-Print Instructions

- 1. To print with Photocentric Liquid Crystal Magna, choose 'HighTemp DL400' and the desired layer thickness when preparing your print file in Photocentric Studio.
- 2. Heat the resin to 60°C for 5 hours or until the resin is fully liquified in the bottle. Failure to do so prior to printing will result in the resin crystalizing, leading to print failures.
- 3. Shake the resin bottle for 2 minutes before pouring into the resin vat.



Post-Print Instructions

- 1. Parts can be washed in 15 minutes using Photocentric Resin Cleaner or alternatively, in 10 minutes using Photocentric Resin Cleaner 30.
- 2. Once washed, rinse with warm water for 2 minutes
- 3. Dry with compressed air to remove any remaining water. Or alternatively, leave to air-dry.
- 4. Place the platform into the Photocentric Cure L2 for a minimum of 2 hours at 60°C or until parts are fully cured (4 hours maximum).
- 5. Remove the platform from the Cure L2 and immediately submerge in cold water for thermal shocking. Parts can be removed from the platform with minimal effort.
- 6. Draining and cleaning the vat is highly recommended after print job completion as the ambient temperature may drop below 23 °C resin crystallization temperature.





